Taiwan Semiconductor

15A, 45V Trench Schottky Rectifiers

FEATURES

- AEC-Q101 qualified
- Patented Trench Schottky technology
- Low power loss, high efficiency
- Ideal for automated placement
- Wettable flank
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- On-board DC/DC converter
- Automotive •

MECHANICAL DATA

- Case: SMPC4.6U
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 104mg (approximately)

| KEY PAR | AMETER | S |
|--------------------|----------|------|
| PARAMETER | VALUE | UNIT |
| I _F | 15 | А |
| V _{RRM} | 45 | V |
| I _{FSM} | 290 | А |
| T _{J MAX} | 175 | °C |
| Package | SMPC4.6U | |



SMPC4.6U

| Anode 1 | \sim | Cathoda 2 |
|---------|--------|-----------|
| Anode 2 | | Cathode 3 |

| ABSOLUTE MAXIMUM RAT | FINGS (T _A = 25°C un | less otherwise | noted) | |
|----------------------------------------------|----------------------------------------|---------------------|-------------|------|
| PARAMETER | | SYMBOL | TSUP15M45SH | UNIT |
| Marking code on the device | | | 15M45 | |
| Repetitive peak reverse voltage | | V _{RRM} | 45 | V |
| Reverse voltage, total rms value | | V _{R(RMS)} | 32 | V |
| Forward current | | I _F | 15 | А |
| Surge peak forward current single | 8.3 ms at T _A = 25°C | | 290 | ^ |
| half sine-wave superimposed on rated load | 1.0 ms at T _A = 25°C | I _{FSM} | 440 | A |
| Junction temperature | | TJ | -55 to +175 | °C |
| Storage temperature | | T _{STG} | -55 to +175 | °C |







| THERMAL PERFORMANCE | | | |
|----------------------------------------|------------------|-----|------|
| PARAMETER | SYMBOL | ТҮР | UNIT |
| Junction-to-lead thermal resistance | R _{θJL} | 4 | °C/W |
| Junction-to-ambient thermal resistance | R _{ejA} | 48 | °C/W |
| Junction-to-case thermal resistance | R _{eJC} | 7 | °C/W |

Thermal Performance Note: Units mounted on PCB (16mm x 16mm Cu pad test board)

| ELECTRICAL SPECIFICAT | IONS ($T_A = 25^{\circ}C$ unless other | erwise noted) | | | |
|-------------------------------------|------------------------------------------------|----------------|------|------|------|
| PARAMETER | CONDITIONS | SYMBOL | ТҮР | MAX | UNIT |
| | IF = 7.5A, TJ = 25°C | | 0.48 | - | V |
| Forward voltage ⁽¹⁾ | I _F = 15.0A, T _J = 25°C | V | 0.51 | 0.60 | |
| Forward voltage | I _F = 7.5A, T _J = 125°C | V _F | 0.37 | - | |
| | I _F = 15.0A, T _J = 125°C | | 0.44 | 0.54 | V |
| | T _J = 25°C | I _R | - | 350 | μA |
| Reverse current @ rated $V_R^{(2)}$ | T _J = 125°C | | - | 20 | mA |
| Junction capacitance | 1 MHz, V _R =4.0V | CJ | 1803 | - | pF |

Notes:

1. Pulse test with PW=0.3 ms

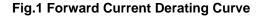
2. Pulse test with PW=30 ms

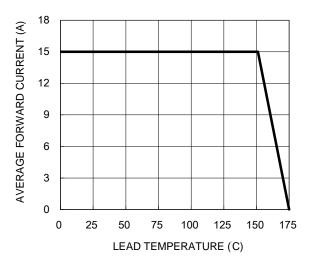
| ORDERING INFORMATION | | |
|----------------------|----------|------------------------|
| ORDERING CODE | PACKAGE | PACKING |
| TSUP15M45SH S1G | SMPC4.6U | 1,500/7" Plastic reel |
| TSUP15M45SH S2G | SMPC4.6U | 6,000/13" Plastic reel |



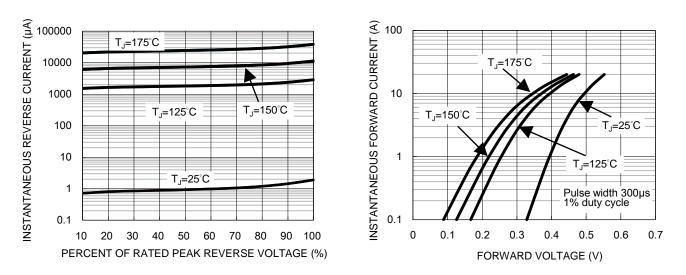
CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$









10000

1000

100

1

f=1.0MHz Vsig=50mVp-p

CAPACITANCE (pF)

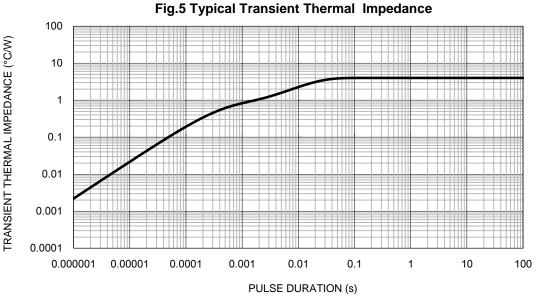


Fig.2 Typical Junction Capacitance

10

Fig.4 Typical Forward Characteristics

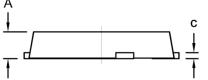
REVERSE VOLTAGE (V)

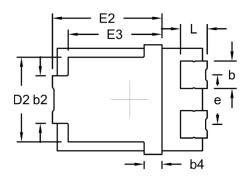
100



PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

SMPC4.6U





SUGGESTED PAD LAYOUT

В

D

F

1

С

1

| DIM. | Unit | (mm) | Unit (| (inch) |
|------|-------------|-------|--------------|--------|
| DIN. | Min. | Max. | Min. | Max. |
| А | 1.00 | 1.20 | 0.039 | 0.047 |
| b | 1.05 | 1.35 | 0.041 | 0.053 |
| b2 | 1.90 | 2.20 | 0.075 | 0.087 |
| b4 | 0.75 (| NOM.) | 0.030 | (NOM.) |
| с | 0.15 | 0.40 | 0.006 | 0.016 |
| D | 4.45 | 4.75 | 0.175 | 0.187 |
| D1 | 4.25 | 4.35 | 0.167 | 0.171 |
| D2 | 3.40 | 3.70 | 0.134 | 0.146 |
| E | 6.35 | 6.65 | 0.250 | 0.262 |
| E1 | 6.05 | 6.15 | 0.238 | 0.242 |
| E2 | 4.40 | 4.80 | 0.173 | 0.189 |
| E3 | 3.94 (NOM.) | | 0.155 (NOM.) | |
| е | 2.08 (| NOM.) | 0.082 | (NOM.) |
| L | 0.94 | 1.24 | 0.037 | 0.049 |
| L1 | 0.05 | 0.35 | 0.002 | 0.014 |
| М | 0.65 | 1.15 | 0.026 | 0.045 |
| Ν | 0.25 | 0.75 | 0.010 | 0.030 |

Package body size D1 and E1 do not include mold flash Mold flash shall not exceed 0.1mm per side

| Symbol | Unit (mm) | Unit (inch) |
|--------|-----------|-------------|
| A | 4.95 | 0.195 |
| В | 4.95 | 0.195 |
| С | 1.60 | 0.063 |
| D | 1.42 | 0.056 |
| E | 6.95 | 0.274 |
| F | 1.04 | 0.041 |

MARKING DIAGRAM

А

1



- E ·

| P/N | = Marking Code |
|-----|----------------|
| YW | = Date Code |
| F | = Factory Code |

| Version:A1909 |
|---------------|
|---------------|



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